BT149 series

Thyristors logic level Rev. 5 — 1 November 2011

Product data sheet

1. **Product profile**

1.1 General description

Passivated, sensitive gate thyristors in a SOT54 plastic package.

1.2 Features and benefits

Designed to be interfaced directly to microcontrollers, logic integrated circuits and other low power gate trigger circuits.

1.3 Applications

General purpose switching and phase control.

1.4 Quick reference data

- V_{DRM} , $V_{RRM} \le 200 \text{ V (BT149B)}$
- V_{DRM} , $V_{RRM} \le 400 \text{ V (BT149D)}$
- V_{DRM} , $V_{RRM} \le 600 \text{ V (BT149G)}$
- $I_{T(RMS)} \le 0.8 A$
- $I_{T(AV)} \le 0.5 A$
- $\blacksquare \quad I_{TSM} \leq 8 \ A.$

Pinning information 2.

Table 1. **Discrete pinning**

Pin	Description	Simplified outline	Symbol
1	cathode (K)		N 1
2	gate (G)		A K
3	anode (A)		G sym037
		SOT54 (TO-92)	



3. Ordering information

Table 2. Ordering information

Type number	Package)	
	Name	Description	Version
BT149B	'-	plastic single-ended leaded (through hole) package; 3 leads	SOT54
BT149D			
BT149G			

4. Limiting values

Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DRM}, V_{RRM}	repetitive peak off-state voltage				
	BT149B		[1] -	200	V
	BT149D		[1] -	400	V
	BT149G		[1] -	600	V
$I_{T(AV)}$	average on-state current	half sine wave; T _{lead} ≤ 83 °C; see <u>Figure 1</u>	-	0.5	А
$I_{T(RMS)}$	RMS on-state current	all conduction angles; see Figure 4 and 5	-	0.8	А
I _{TSM}	non-repetitive peak on-state current	half sine wave; $T_j = 25$ °C prior to surge; see Figure 2 and 3			
		t = 10 ms	-	8	Α
		t = 8.3 ms	-	9	Α
I ² t	I ² t for fusing	t = 10 ms	-	0.32	A ² s
dI _T /dt	repetitive rate of rise of on-state current after triggering	$I_{TM} = 2 \text{ A}; I_G = 10 \text{ mA};$ $dI_G/dt = 100 \text{ mA/}\mu\text{s}$	-	50	A/μs
I _{GM}	peak gate current		-	1	Α
V_{GM}	peak gate voltage		-	5	V
V_{RGM}	peak reverse gate voltage		-	5	V
P_{GM}	peak gate power		-	2	W
P _{G(AV)}	average gate power	over any 20 ms period	-	0.1	W
T _{stg}	storage temperature		-40	+150	°C
T _j	junction temperature		-	125	°C

^[1] Although not recommended, off-state voltages up to 800 V may be applied without damage, but the thyristor may switch to the on-state. The rate of rise of current should not exceed 15 A/μs.

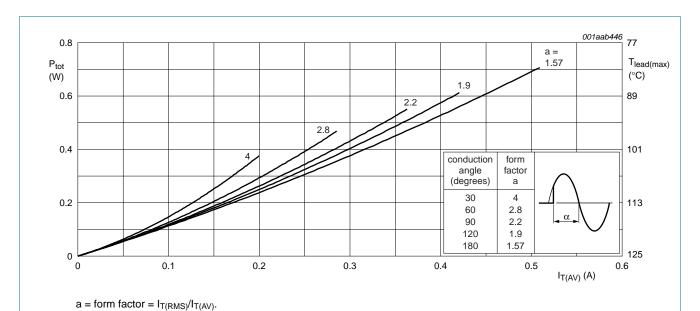
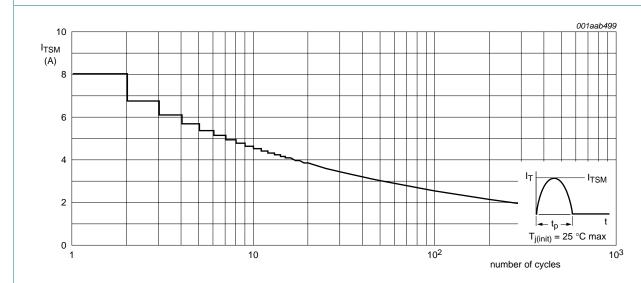


Fig 1. Total power dissipation as a function of average on-state current; maximum values



f = 50 Hz.

Fig 2. Non-repetitive peak on-state current as a function of the number of sinusoidal current cycles; maximum values

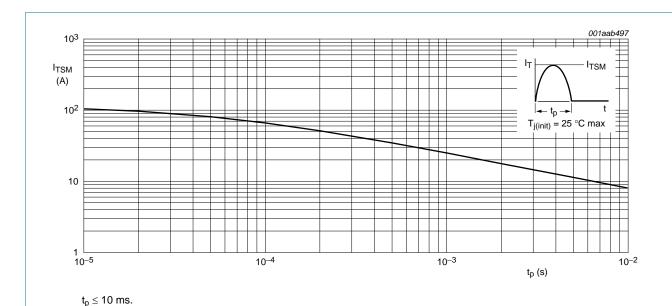


Fig 3. Non-repetitive peak on-state current as a function of pulse width for sinusoidal currents; maximum values

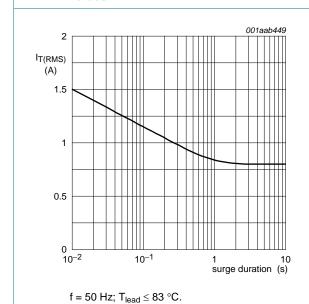
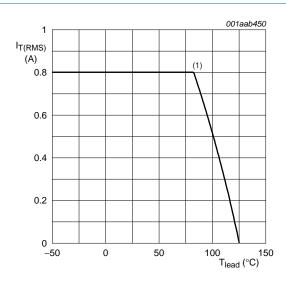


Fig 4. RMS on-state current as a function of surge duration, for sinusoidal currents; maximum values



(1) $T_{lead} = 83 \, ^{\circ}C$

Fig 5. RMS on-state current as a function of lead temperature; maximum values

5. Thermal characteristics

Table 4. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j\text{-lead})}$	thermal resistance from junction to lead		-	-	60	K/W
R _{th(j-a)}	thermal resistance from junction to ambient	printed-circuit board mounted; lead length = 4 mm	-	150	-	K/W

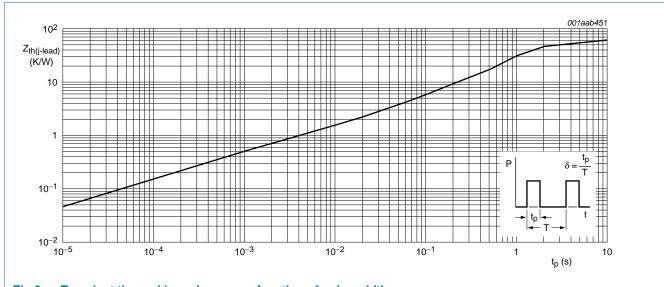


Fig 6. Transient thermal impedance as a function of pulse width

6. Characteristics

Table 5. Characteristics

 $T_i = 25$ °C unless otherwise stated.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static char	racteristics					
I _{GT}	gate trigger current	$V_D = 12 \text{ V}; I_T = 10 \text{ mA};$ gate open circuit; see Figure 8	-	50	200	μΑ
IL	latching current	V_D = 12 V; I_{GT} = 0.5 mA; R_{GK} = 1 k Ω ; see <u>Figure 10</u>	-	2	6	mA
I _H	holding current	V_D = 12 V; I_{GT} = 0.5 mA; R_{GK} = 1 k Ω ; see <u>Figure 11</u>	-	2	5	mA
V_{T}	on-state voltage	I _T = 1.2 A	-	1.25	1.7	V
V_{GT}	gate trigger voltage	I _T = 10 mA; gate open circuit; see Figure 7				
		V _D = 12 V	-	0.5	0.8	V
		$V_D = V_{DRM(max)}$; $T_j = 125 ^{\circ}C$	0.2	0.3	-	V
I _D , I _R	off-state leakage current	$V_D = V_{DRM(max)}$; $V_R = V_{RRM(max)}$; $T_j = 125 ^{\circ}\text{C}$; $R_{GK} = 1 \text{k}\Omega$	-	0.05	0.1	mA
Dynamic o	haracteristics					
dV _D /dt	critical rate of rise of off-state voltage	$V_{DM} = 67 \% V_{DRM(max)}; T_j = 125 °C;$ exponential waveform; see Figure 12				
		gate open circuit	-	25	-	V/μs
		$R_{GK} = 1 k\Omega$	500	800	-	V/μs
t _{gt}	gate controlled turn-on time	$I_{TM} = 2 \text{ A}; V_D = V_{DRM(max)};$ $I_G = 10 \text{ mA}; dI_G/dt = 0.1 \text{ A/}\mu\text{s}$	-	2	-	μS
t _q	circuit commuted turn-off time	$V_D = 67 \% V_{DRM(max)}; T_j = 125 °C;$ $I_{TM} = 1.6 A; V_R = 35 V;$ $dI_{TM}/dt = 30 A/\mu s; dV_D/dt = 2 V/\mu s;$ $R_{GK} = 1 k\Omega$	-	100	-	μS

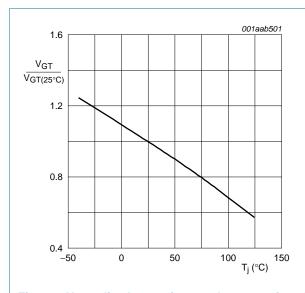


Fig 7. Normalized gate trigger voltage as a function of junction temperature

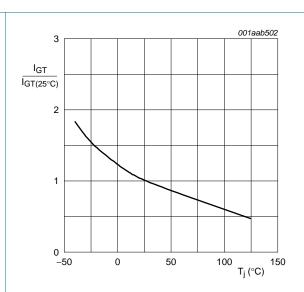
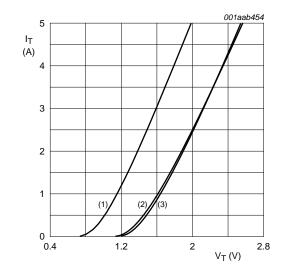


Fig 8. Normalized gate trigger current as a function of junction temperature

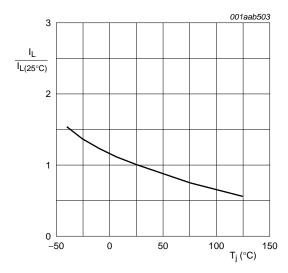


 $V_{O} = 1.067 V.$

 $R_S = 0.187 \Omega$.

- (1) $T_j = 125$ °C; typical values
- (2) $T_j = 125 \,^{\circ}C$; maximum values
- (3) $T_j = 25$ °C; maximum values

Fig 9. On-state current characteristics



 $R_{GK} = 1 k\Omega$.

Fig 10. Normalized latching current as a function of junction temperature

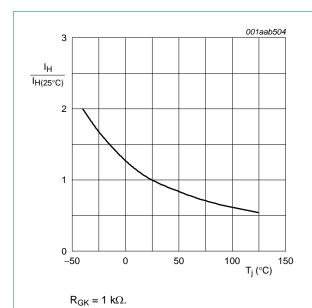
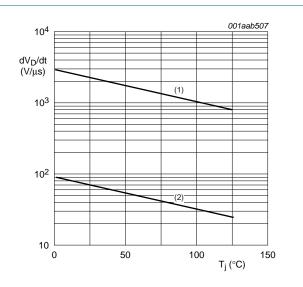


Fig 11. Normalized holding current as a function of junction temperature



- (1) $R_{GK} = 1 k\Omega$.
- (2) Gate open circuit.

Fig 12. Critical rate of rise of off-state voltage as a function of junction temperature; typical values

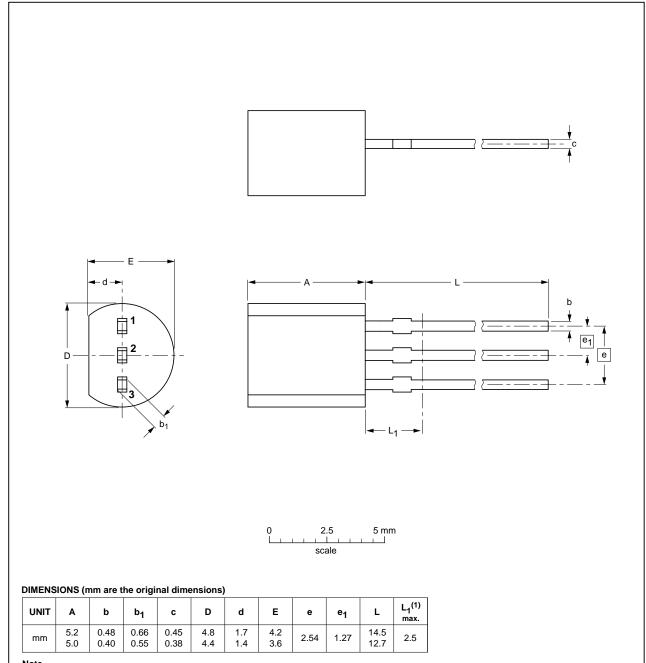
7. Package information

Epoxy meets requirements of UL94 V-0 at ½ inch.

8. Package outline

Plastic single-ended leaded (through hole) package; 3 leads

SOT54



Note

1. Terminal dimensions within this zone are uncontrolled to allow for flow of plastic and terminal irregularities.

OUTLINE		REFERENCES			EUROPEAN ISSUE DAT	ISSUE DATE	
VERSION	IEC J	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT54		TO-92	SC-43A			04-06-28 04-11-16	

Fig 13. Package outline SOT54 (TO-92)

BT149_SER

9. Revision history

Table 6. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BT149_SER v.5	20111101	Product data sheet		BT149_SERIES v.4
Modifications:	guidelines	of this data sheet has been of NXP Semiconductors.		·
	 Legal texts 	have been adapted to the r	new company name whe	ere appropriate.
BT149_SERIES v.4	20040820	Product data sheet		BT149_SERIES v.3
BT149_SERIES v.3	20010902	Product specification		BT149_SERIES v.2
BT149_SERIES v.2	20010901	Product specification		BT149_SERIES v.1
BT149_SERIES v.1	19970901	Product specification		-

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10.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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NXP Semiconductors

BT149 series

Thyristors logic level

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BT149 series

Thyristors logic level

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